



## **FluxPlus™ Paste Flux**

Flux characteristics are the most important feature when dispensing and reflowing solder paste. We provide a wide array of formulations available in No Clean (NC), Water Soluble (WS), Rosin Mildly Activated (RMA), and Rosin Activated (RA) to suit your application needs. We supply fluxes formulated to work with any alloy and heating process, perfect for rework and BGA applications.

### **Rosin Mildly Activated (RMA)**

Consists of rosin, solvent, and a small amount of activator. Most RMA flux is fairly low in activity and best suited to easily solderable surfaces. RMA flux residue is clear, soft, non-corrosive, and non-conductive. Cleaning is optional. Residue may be removed with an appropriate solvent.

### **No Clean (NC)**

Consists of rosin, solvent, and a small amount of activator. NC flux has low activity and is suited to easily solderable surfaces. NC residue is clear, hard, noncorrosive, non-conductive, and designed to be left on your assembly. Residue may be removed with an appropriate solvent.